Product data sheet

1. General description

Ultrafast power diode in a 2-lead TO220F plastic package.

2. Features and benefits

- Fast switching
- Low thermal resistance
- Soft recovery characteristic
- · Low forward voltage drop
- Low switching loss
- · High thermal cycling performance

3. Applications

- · Output rectifiers in high frequency switched-mode power supplies
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values		Unit		
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		600				V
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _h ≤ 49 °C; Fig. 1; Fig. 2	15				А
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _h ≤ 49 °C; square-wave pulse	30			А	
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	130 143		Α		
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse			Α		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; <u>Fig. 4</u>		-	1.16	1.38	V
		I _F = 15 A; T _j = 150 °C		-	1.01	1.2	V
Dynamic	characteristics				,		
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 5$		-	50	60	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode		K A
mb	n.c.	mounting base; isolated		001aaa020
			1 2 SOD113 (2-lead TO-220F)	

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BYT79X-600	TO220F	BYT79X-600,127	Tube	50	SOD113	28-Aug-2015

7. Marking

Table 4. Marking codes

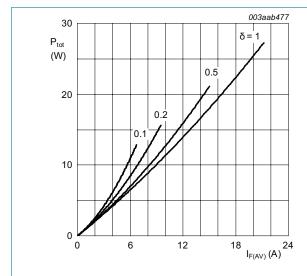
Type number	Marking codes		
	Assembly factory: d	Assembly factory: A	
BYT79X-600	BYT79X 600 PJdxxxx xx	BYT79X 600 PJAxxxx xx	

8. Limiting values

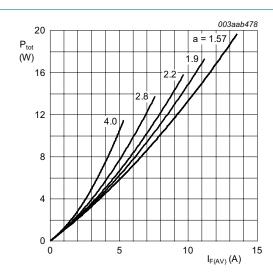
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V_R	reverse voltage	δ = 1.0 ; square-wave pulse	600	V
I _{F(AV)}	average forward current	$δ = 0.5$; square-wave pulse; $T_h \le 49$ °C; Fig. 1; Fig. 2	15	А
I _{FRM}	repetitive peak forward current	$δ = 0.5$; $t_p = 25 \mu s$; $T_h \le 49 °C$; square-wave pulse	30	А
I _{FSM}	non-repetitive peak	$t_p = 10 \text{ ms}; T_{j(init)} = 25 \text{ °C}; \text{ sine-wave pulse};$	130	А
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	143	А
T _{stg}	storage temperature		-55 to 150	°C
T _j	junction temperature		150	°C



 $I_{\text{F(AV)}} = I_{\text{F(RMS)}} \times \sqrt{\delta}$ Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



a = form factor = I_{F(RMS)}/ I_{F(AV)}
 Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance	with heatsink compound; Fig 3	-	-	4.8	K/W
	from junction to heatsink	without heatsink compound	-	-	5.9	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W

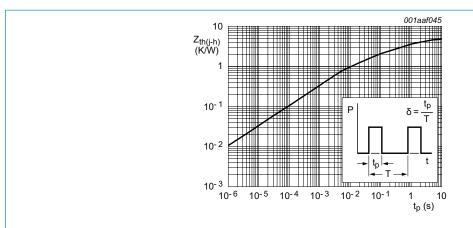


Fig. 3. Transient thermal impedance from junction to heatsink as a function of pulse width

10. Isolation characteristics

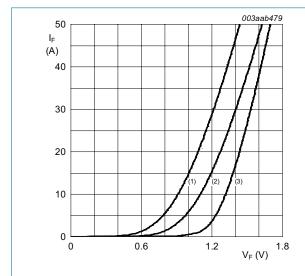
Table 7. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	50 Hz ≤ f ≤ 60 Hz; RH ≤ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from cathode to external heatsink	-	10	-	pF

11. Characteristics

Table 8. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.16	1.38	V
		I _F = 15 A; T _j = 150 °C	-	1.01	1.2	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	5	50	μA
		V _R = 600 V; T _j = 100 °C	-	0.2	0.8	mA
Dynamic	characteristics					,
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 5	-	50	60	ns
I _{RM}	peak reverse recovery current	$I_F = 10 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 100 \text{ °C}; Fig. 5$	-	3	5.2	А
V _{FR}	forward recovery voltage	$I_F = 10 \text{ A}; dI_F/dt = 10 \text{ A/}\mu\text{s}; Fig. 6$	-	3.2	-	V
Q _r	recovered charge	$I_F = 2 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 20 \text{ A/}\mu\text{s}$; Fig. 5	-	40	70	nC



(1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values (3) T_j = 25 °C; maximum values



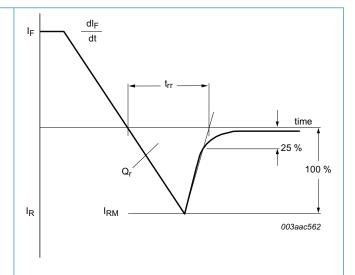
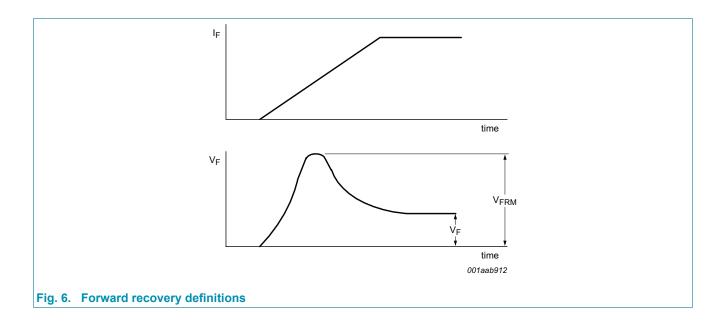


Fig. 5. Reverse recovery definitions; ramp recovery

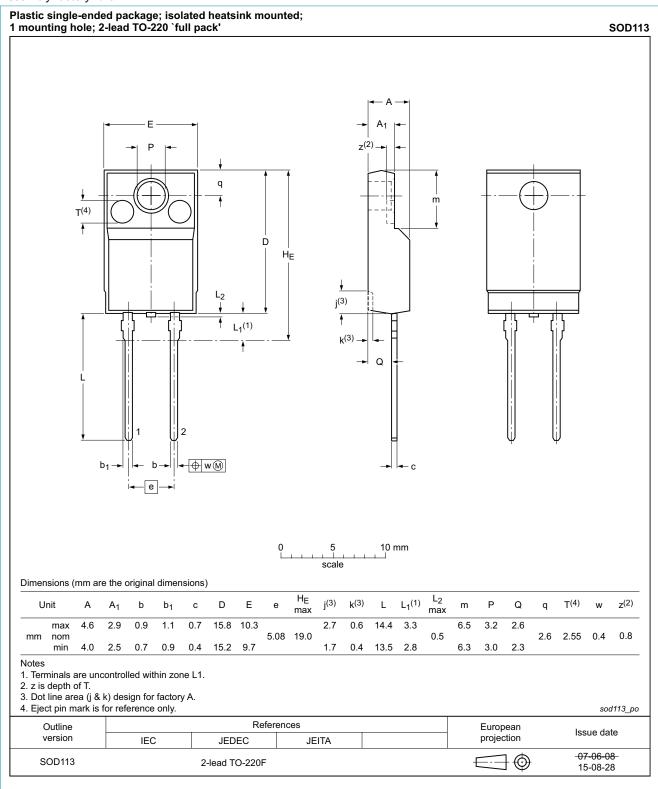
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Rectifier diode ultrafast



12. Package outline

Assembly factory: d & A



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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